IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent of MEMC Electronic Materials, Inc.

Patent No. 6,858,307

Issued February 22, 2005

For METHOD FOR THE PRODUCTION OF LOW DEFECT DENSITY SILICON

January 8, 2007

LETTER TO THE PATENT AND TRADEMARK OFFICE

TO THE COMMISSIONER FOR PATENTS,

SIR:

The above-identified patent should read at the places indicated as follows:

Claim 6 should have been removed from the claim set during prosecution, as it was indicated as "cancelled" in Amendment A, dated October 13, 2003.

REMARKS

The claims of Patent No. 6,858,307 have been compared with the file of applicant's counsel.

It is requested that the instant letter be placed in the file of Patent No. 6,858,307 for the purpose of calling attention to immaterial typographical errors in the printed patent, the correction of which should be apparent. This letter is being filed to avoid burdening the Patent and Trademark Office with a request for a formal certificate of correction.

Respectfully submitted

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